Electronic Acl	knowledgement Receipt			
EFS ID:	1743374			
Application Number:	10632552			
International Application Number:				
Confirmation Number:	2572			
Title of Invention:	Semiconductor multi-package module having package stacked over die-up flip chip ball grid array package and having wire bond interconnect between stacked packages			
First Named Inventor/Applicant Name:	Marcos Karnezos			
Customer Number:	22470			
Filer:	Joseph Ernest Root/Lynne Milliot			
Filer Authorized By:	Joseph Ernest Root			
Attorney Docket Number:	CPAC 1017-5			
Receipt Date:	03-MAY-2007			
Filing Date:	02-AUG-2003			
Time Stamp:	20:06:41			
Application Type:	Utility			

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Extension of Time	20070503_Petition_Extensio n_of_Time.pdf	41409	no	1
Warnings:					

Information:						
2	Fee Worksheet (PTO-06)	fee-info.pdf	8231	no	2	
Warnings:						
Information	:					
	Total Files Size (in bytes): 49640					

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.